



SPP3052

P-Channel Enhancement Mode MOSFET

DESCRIPTION

The SPP3052 is the P-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application, such as DC/DC converter and Desktop computer power management.

The package is universally preferred for commercial industrial surface mount applications

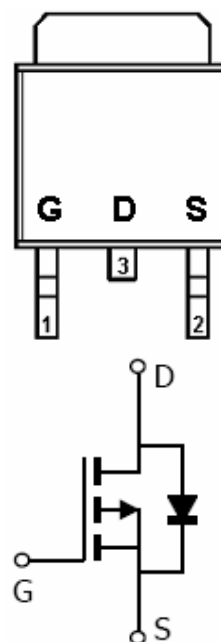
APPLICATIONS

- Power Management in Desktop Computer
- DC/DC Converter
- LCD Display inverter

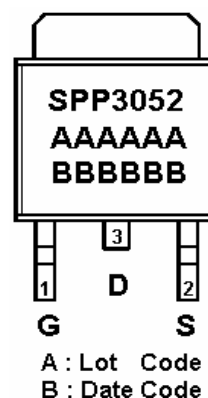
FEATURES

- ◆ -30V/- 25A, $R_{DS(ON)}=50m\Omega@V_{GS}=-10V$
- ◆ -30V/- 16A, $R_{DS(ON)}=85m\Omega@V_{GS}=-5V$
- ◆ Super high density cell design for extremely low $R_{DS(ON)}$
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ TO-252-2L package design

PIN CONFIGURATION (TO-252-2L)



PART MARKING





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PIN DESCRIPTION

Pin	Symbol	Description
1	G	Gate
2	S	Source
3	D	Drain

ORDERING INFORMATION

Part Number	Package	Part Marking
SPP3052T252RG	TO-252-2L	SPP3052

※ Week Code : A ~ Z(1 ~ 26) ; a ~ z(27 ~ 52)

※ SPP3052T252RG : Tape Reel ; Pb – Free

ABSOLUTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter		Symbol	Typical	Unit
Drain-Source Voltage		V _{DSS}	-30	V
Gate –Source Voltage		V _{GSS}	±20	V
Continuous Drain Current(T _J =150°C)	T _A =25°C	I _D	-25	A
	T _A =70°C		-18	
Pulsed Drain Current		I _{DM}	-100	A
Continuous Source Current(Diode Conduction)		I _S	-15	A
Power Dissipation	T _A =25°C	P _D	40	W
	T _A =70°C		20	
Operating Junction Temperature		T _J	-55/150	°C
Storage Temperature Range		T _{STG}	-55/150	°C
Thermal Resistance-Junction to Ambient		R _{θJA}	105	°C/W



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ELECTRICAL CHARACTERISTICS

(T_A=25°C Unless otherwise noted)

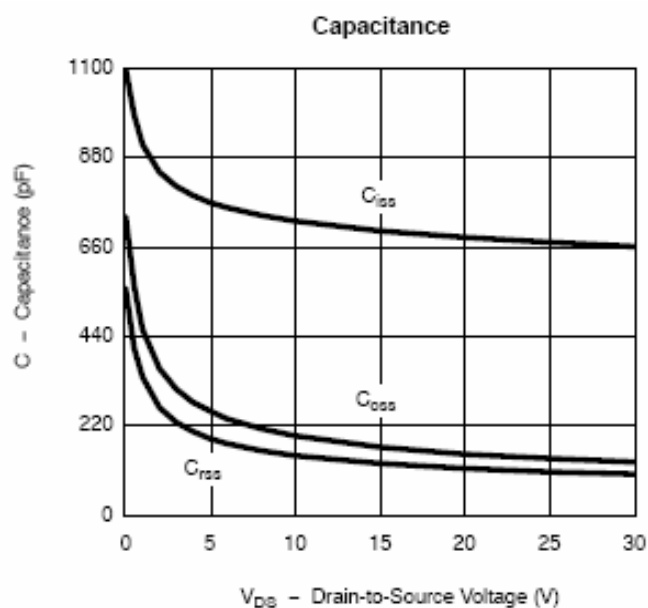
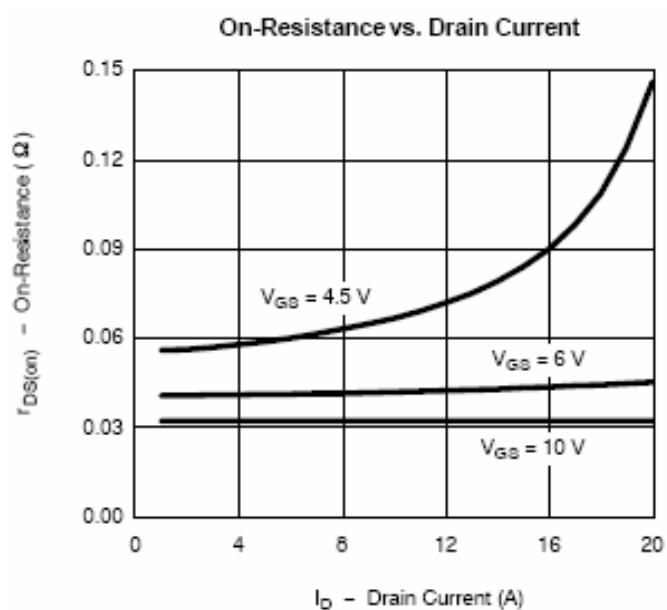
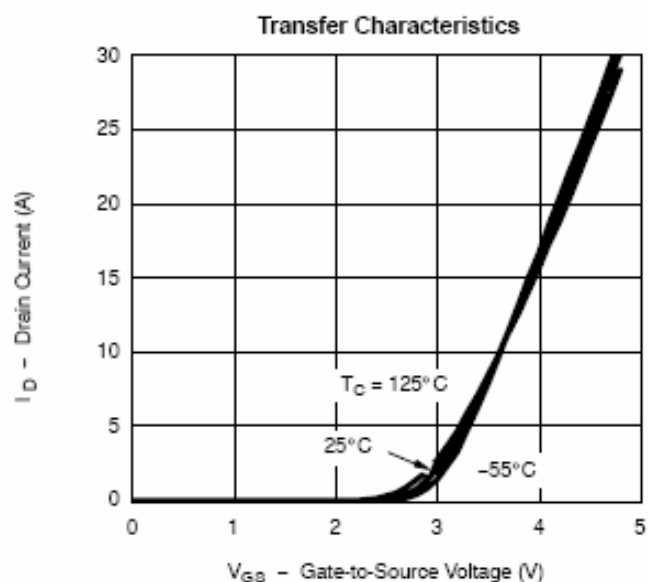
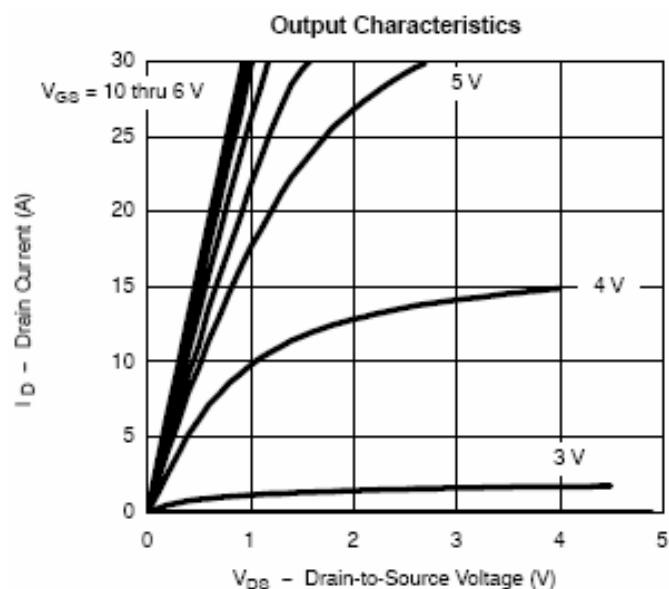
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =-250uA	-30			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250uA	-1.0		-3.0	
Gate Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-24V, V _{GS} =0V			-1	uA
		V _{DS} =-24V, V _{GS} =0V T _J =85°C			-5	
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =-10V, I _D =-25A		0.040	0.050	Ω
		V _{GS} =- 5V, I _D =-16A		0.068	0.085	
Forward Transconductance	g _{fs}	V _{DS} =-10V, I _D =-8A		8		S
Diode Forward Voltage	V _{SD}	I _S =-16A, V _{GS} =0V		-0.8	-1.2	V
Dynamic						
Total Gate Charge	Q _g	V _{DS} =-15V, V _{GS} =-10V I _D = -3.5A		16	24	nC
Gate-Source Charge	Q _{gs}			2.3		
Gate-Drain Charge	Q _{gd}			4.5		
Input Capacitance	C _{iss}	V _{DS} =-15V, V _{GS} =0V f=1MHz		680		pF
Output Capacitance	C _{oss}			120		
Reverse Transfer Capacitance	C _{rss}			75		
Turn-On Time	t _{d(on)}	V _{DD} =-15V, R _L =15Ω I _D ≡-1.0A, V _{GEN} =-10V R _G =6Ω		14	25	ns
	t _r			15	26	
Turn-Off Time	t _{d(off)}			42	70	
	t _f			30	50	



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TYPICAL CHARACTERISTICS

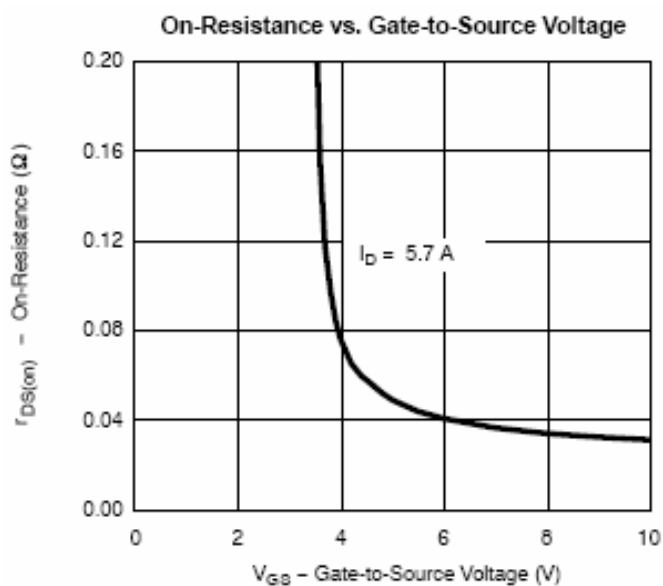
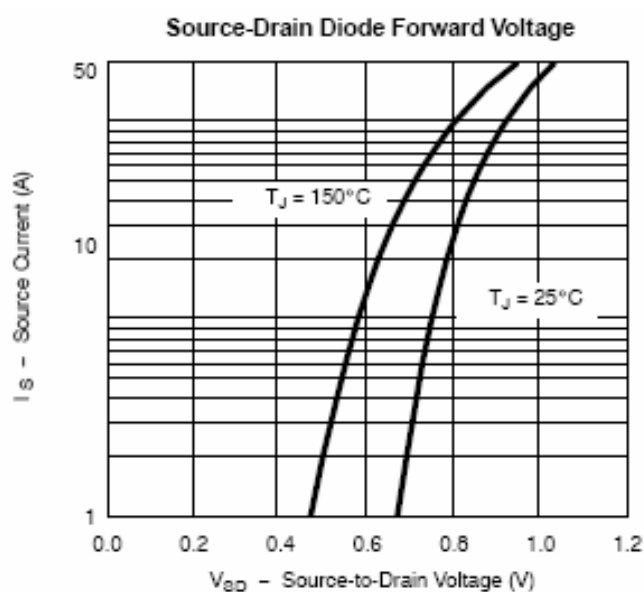
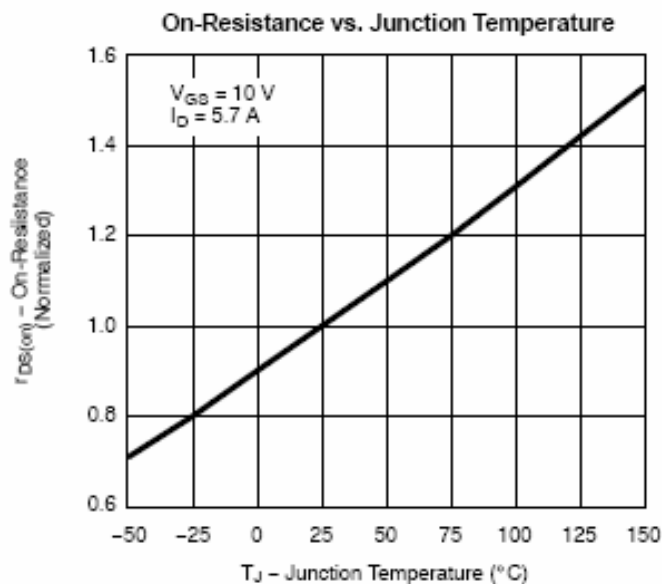
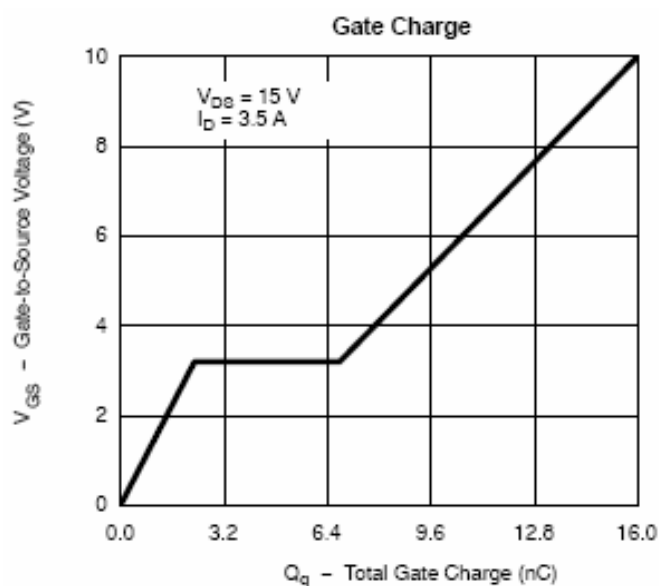




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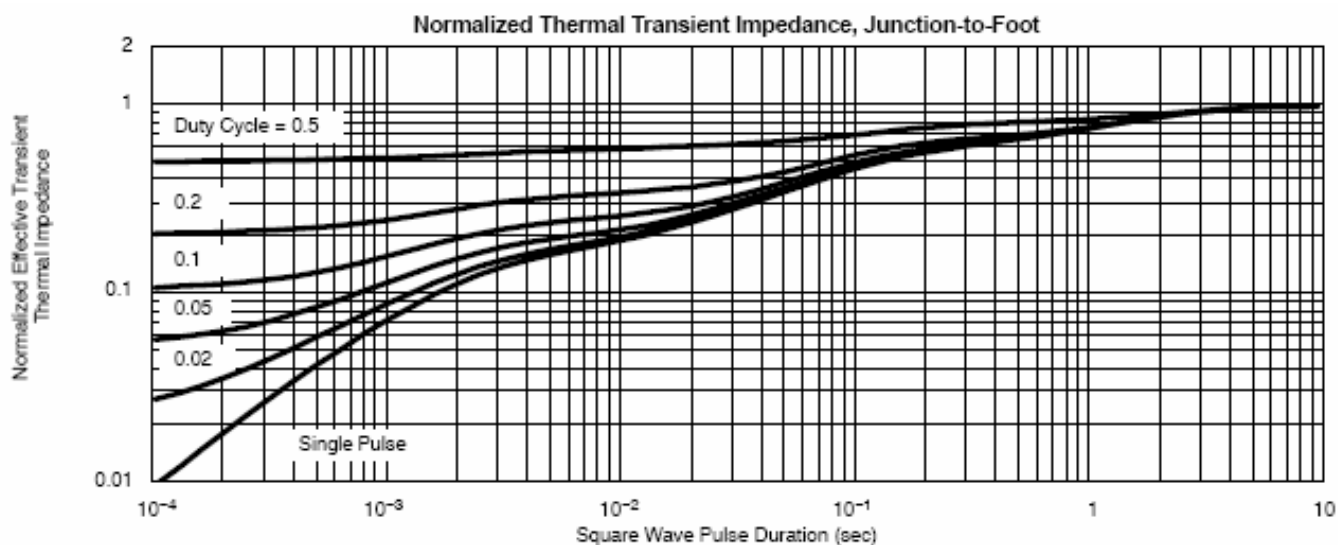
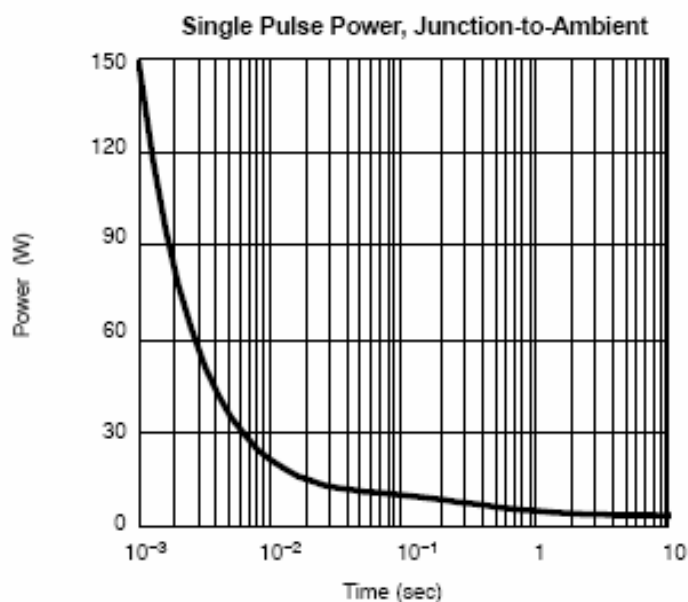
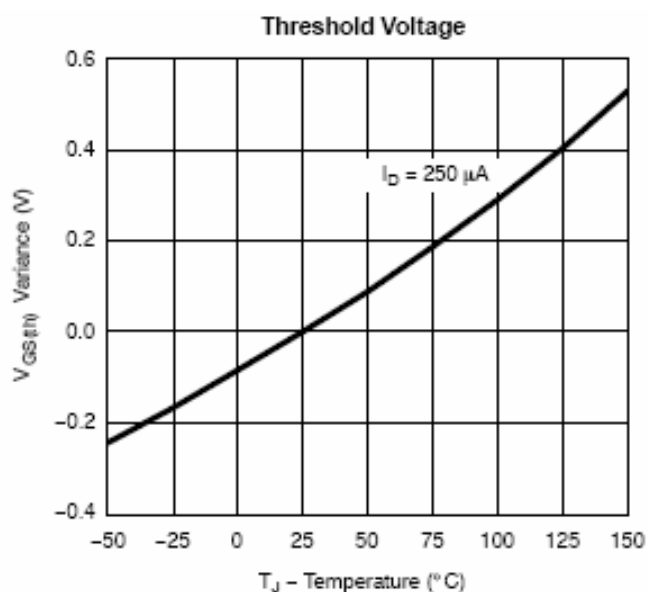




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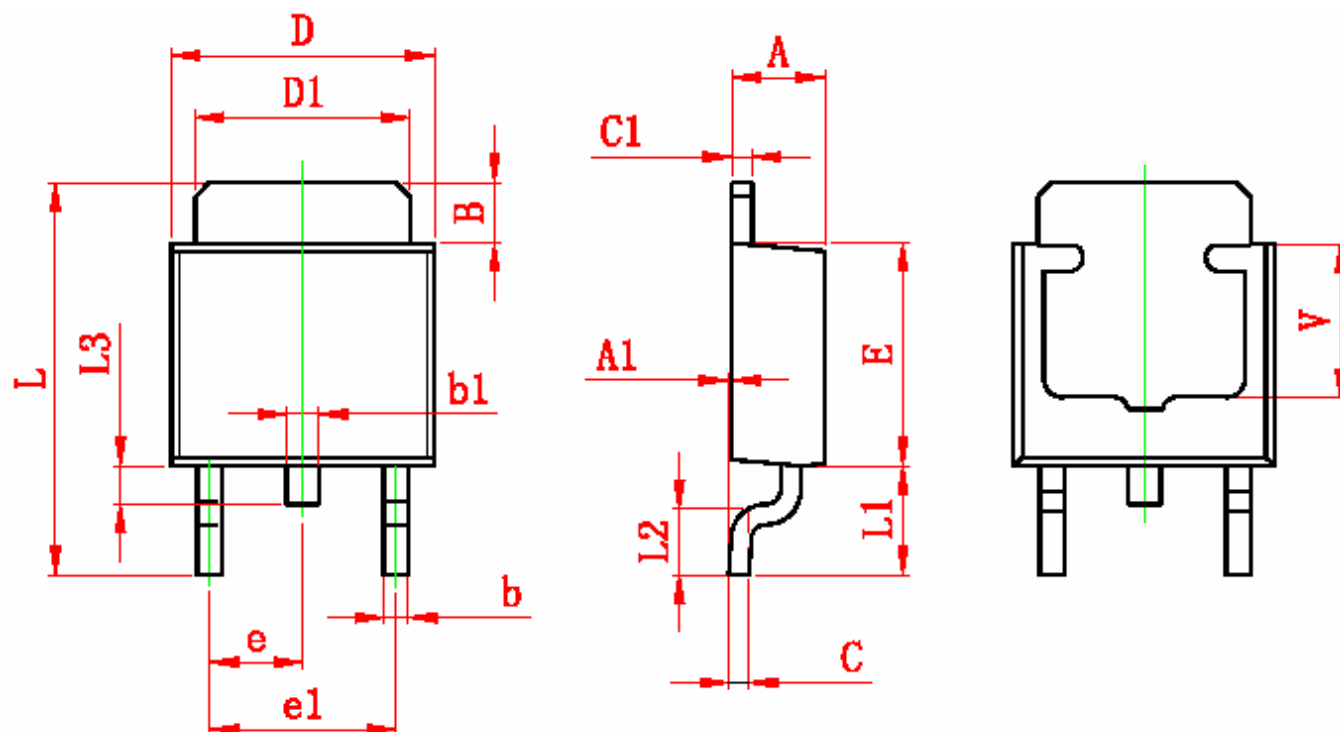




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TO-252-2L PACKAGE OUTLINE



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
B	1.350	1.650	0.053	0.065
b	0.500	0.700	0.020	0.028
b1	0.700	0.900	0.028	0.035
c	0.430	0.580	0.017	0.023
c1	0.430	0.580	0.017	0.023
D	6.350	6.650	0.250	0.262
D1	5.200	5.400	0.205	0.213
E	5.400	5.700	0.213	0.224
e	2.300 TYP.		0.091 TYP.	
e1	4.500	4.700	0.177	0.185
L	9.500	9.900	0.374	0.390
L1	2.550	2.900	0.100	0.114
L2	1.400	1.780	0.055	0.070
L3	0.600	0.900	0.024	0.035
V	3.800 REF.		0.150 REF.	



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